Quasi-ballistic transport in H gTe quantum -well nanostructures

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The transport properties of m icrom eter scale structures fabricated from high-m obility HgTe quantum -wells have been investigated. A special photoresist and T i m asks were used, which allow for the fabrication of devices with characteristic dimensions down to 0:45 m. Evidence that the transport properties are dom inated by ballistic e ects in these structures is presented. M onte C arlo simulations of sem i-classical electron trajectories show good agreement with the experiment.

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The giant Zeem an e ect and Rashba spin orbit (so) splitting¹ in magnetic two dimensional electron gas (2DEG) structures have recently aroused much interest due to their possible application in spintronics. These two e ects are largest in the narrow gap II-VI sem iconducting materials based on HgTe with which high-m obility quantum -well (QW) structures have been realized². In addition it is possible to replace Hg substitutionally by isoelectronic magnetic atom s such as M n, which enhances the electric q-factor, i.e. q = 50 60, whereas the sample mobilities are only weakly a ected³. Therefore, HgTeQW structures o er interesting opportunities to study spin related transport e ects. One goal is the exploration of the electronic spin behavior in nanostructures in which transport is dom inated by ballistic effects. However, up to now ballistic transport has not been dem onstrated in HqTeQW structures, mainly due to speci c m aterial properties that prevent the application of wellknown and established nano-structuring technologies used for Si and G aAs based structures.

Here we report the observations of ballistic transport in H gTe. In a cross shaped geom etry with channelwidths of 0.45 and 1.0 m a non-local resistance signal is detected. The signal can be explained qualitatively and quantitatively by an approach based on the Landauer-Buttiker (LB) form ula⁴ and classical M onte C arbo (M C) simulations which consider the sample geometry only. The scattering time related to the transport m ean free path is used as a t parameter. The scattering time , which is obtained from these simulations agrees well with that obtained from transport m easurem ent on m acroscopic H all bar structures.

The n-type asymmetrically modulation doped QW s were epitaxially grown in a Riber 2300 MBE system on $Cd_{0:96}Zn_{0:04}Te$ (001) substrates^{2,5}. A fter an approximately 60 nm thick CdTe bu er layer, grown at 315 C, the CdI₂ modulation doped HgTe QW s were grown at 180 C. The barriers consist of Hg_{0:3}Cd_{0:7}Te layers. The 9 nm thick iodine doped layer in the lower barrier is separated from the quantum well by a 11 nm spacer. The QW width is 12 nm. Sam ple parameters such as carrier concentration, mobility and Rashba s-o splitting were obtained from ac and dc measurements of a standard H all bar in an ⁴He bath cryostat with magnetic elds

perpendicular to the 2D EG up to 7 T. The Hallbar pattern was de ned by optical lithography and wet chem ical etching. A carrier concentration of 1:7 $10^{16} {\rm m}^2$ and a carrier m obility of 62 m²=(V s), which corresponds to a Ferm i wave vector $k_{\rm F}$ of 327 $10^8 {\rm m}^1$ and a transport m ean free path $l_{\rm m~fp}$ of 1:3 $10^{-6} {\rm m}$, were obtained for the sam ple discussed here. Concluding from these results, it should be possible to observe ballistic transport e ects in devices fabricated from this material with an active area of less than 1 m 2 .

In standard nano-structuring lithographical processes, polym ethylm ethacrylate (PM M A) in conjunction with electron beam lithography is used to fabricate such structures. However, for epitaxially grown HgTe sam ples this is not possible due to the high bake-out tem perature necessary for PM M A of about 200 C. Tem peratures exceeding 100 C cause deterioration of the HgTeQW structures by interdi usion of well and barrier m aterials. A s an alternative, we have used the photoresist A RU 4060/3 (A llresist). This resist can be used not only for optical but also for electron beam lithographical pattern transfer. The advantage of this resist is the low bake-out tem perature. For our sam ples a bake-out of 2 m in at 80 C was su cient, which ensures that the sam ple structures rem ain una ected.

Sam ples were fabricated which exhibit a cross-shape geometry with lead widths of 1.0 m (structure A) and

0.45 m (structure B). A scanning electron m icroscope image of structure B is shown in Fig. 1. These crosses have been written using an acceleration voltage of 2.5 kV. The positive resist was developed and Tiwas evaporated onto the sample to serve as an etch mask for the subsequent wet chem ical etching process. Tim asks must be used to avoid the strong under-etching that occurs with the use of a simple photoresist mask together with the etchant described below. Contact pads were fabricated in an optical lithography step with standard optical photoresist (M icroresist m a-P 215). Both optical and e-beam pattern were etched in a dilute solution of Br₂ in ethylene glycolat room tem perature for 30 s. A fler etching about 150 nm into the CdTe bu er layer, the resist and the Ti m ask were removed with aceton and a 2:1 H_2O HF (50%) solution for 10 s, respectively. O hm ic contacts were fabricated by therm albonding with indium .

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Quasi-dc, low frequency (13 Hz) ac measurements with an excitation voltage of 150 V were carried out using lock-in techniques. Various contact combinations have been used to characterize the sam ple after the etching process. In the Hall geometry (I: 1! 3, V: 2! 4, c.f. Fig. 1) the carrier concentration was found to be the sam e as that of macroscopic sam ples and therefore shows clearly, that the sam ple properties have not been changed by the fabrication process.

In order to dem onstrate that the transport properties are dom inated by ballistic e ects we have perform ed non-local transport m easurem ents in di erent contact arrangem ents, which previously have been dem onstrated in high m obility G aAs nano-structures^{6,7}. O ne of the m ost prom inent e ects is the non-local bend resistance (NLR). This signal is measured by passing current through contacts 1 and 2, while the voltage is measured between contacts 3 and 4 (see Fig. 1). The bend resistance is obtained simply by dividing the voltage V_{3,4} by the injected current. If the transport were dom inated by di usive scattering, no voltage signal would be expected to appear between contacts 3 and 4 in this geometry, whereas in the ballistic regime, electrons injected from contact 1 into the cross reach the opposite channel before they are scattered. This leads to charge accumulation at contact area 3 and thus to the NLR signal. Applying a small magnetic eld perpendicular to the 2DEG plane de ects the ballistic electrons and the voltage signal between 3 and 4 decreases.

The results are shown for a 1.0 and 0.45 m cross in Fig. 2. The NLR signal is indeed observed, which is direct evidence of ballistic transport in this device. A sexpected, the signal exhibits a pronounced maximum around B = 0.W ith an applied eld the signal decreases, exhibiting a large dip with a negative NLR signal before it approaches zero in the high eld range (B > 2T). This behavior of the NLR signal can be qualitatively understood by applying the LB form alism. In our geom etry the resulting NLR is derived to be as follow s:

$$(\mathbb{R}_{12;34} =)\frac{V_{c}}{I_{i}} = \frac{h}{2e^{2}} \frac{T^{2} t_{r}t_{l}}{(t_{r} + t_{l})(2T^{2} + 2(t_{r} + t_{l})T + t_{r}^{2} + t_{l}^{2})}$$
(1)

where in our notation, T is the transm ission probability of electrons from contact 1 in contact 3, and t_1 and t_r are the transm ission probabilities from contact 1 to contacts 2 and 4 respectively.

C om paring this result with the data presented in F ig. 2, one can see that at zero magnetic eld the NLR signal is dom inated by electrons that travel ballistically from contact 1 to 3 (T^2 , Eq.(1)). This signal is reduced by electrons which reach either the left or right contact ($t_r t_1$, Eq.(1)). At zero magnetic eld this corresponds to electrons that are either in jected outside the acceptance angle of contact 3 or are scattered by unintentional im – purities. In a magnetic eld the electrons are de ected due to the Lorentz force either tow and the left or the right contact, which in plies that the NLR should decrease and

approach zero, i.e., T = 0 and, either $t_1 = 0$ or $t_r = 0$. However, due to the boundary scattering processes mentioned above, an interm ediate eld regim e exists where the signal becomes negative. In this regime the so called rebound trajectories⁷ may cause the product t_1t_r to exceed T^2 . Enlarging the B eld further will guide all electrons to only one contact (T^2 ! 0 and, either t_r ! 0 or t_1 ! 0) and the NLR becomes zero.

In the inset of Fig. 2 one can see that in the regime where R_{12;34} is expected to approach zero, Shubnikov-de Haas oscillations, which are not included in Eq. 1, are superimposed on the signal. However, the ratio of the absolute m agnitude of the positive signal at B = 0 and the largest negative value is rather sm all com pared to the published results for high mobility G aAs structures 6,7,8 . The main reason for this di erence is the comparatively short m ean free path, which is of the order of the device dimensions in the present case. Therefore, it is plausible that impurity scattering in the cross area increases the transm ission probability to contacts 2 and 4, leading to a reduction in the NLR signal at zero magnetic eld. This e ect is also observed, when the device size is increased; the NLR signal for the 1.0 m structure is much smaller than that for the 0.45 m structure, as shown in Fig. 2. In a rst approximation the ratio of the signal for these two structures can be used to estim ate the carrier m ean free path in the cross area. The signal is proportional to the num ber of electrons that reach contact 3 ballistically $(/ \exp(L=l_{m fp}))$ reduced by those electrons that are scattered into the contacts 2 and 4 (/ 1 exp($L=l_m f_p$)). Evaluating the values deduced from Fig.2 a $l_{m fp}$ 12 m is obtained which is in good agreem ent with the average m ean-free path for the m acroscopic sam ple.

In order to put these considerations on a m ore quantitative basis we have used a M C simulation of the classical electron trajectories in which electrons with an arbitrary velocity distribution are injected through contact 1 into the cross. In this model the electrons are then specularly rejected at the sample boundaries. The electrons that reach the individual contacts are counted. This num ber is proportional to the corresponding transm ission probability^{7,9}. Quantitatively, the experim ental results can not be fully explained by purely ballistic transport and boundary scattering. From the measurements (Fig. 2) one observes that the signal exhibits additional ne structure which is not induced by electronic noise. This nestructure is fully reproducible and stable in time provided the sample is kept at low temperatures. We identify the ne structure as universal conductance uctuation (UCF) electronic interference e ects due to the random distribution of scatterers within the cross area. Evidently, MC simulations of classical electron trajectories are not appropriate to simulate these interference e ects.

However, the overall line shape and am plitude of the NLR signal can be reproduced by MC calculations when additional random scattering is considered, i.e. the ballistic propagation is altered random ly for electrons that dwell longer than the scattering time in the cross area. Fig. 3 shows the resulting NLR curve. For a scattering time of = 1:1 10¹² s a good agreement with the experimental data is obtained. This value in plies a mean free path of 0:9 m and agrees well with the = 1:6 10¹² s () $l_{m\,fp} = 1:3$ m), obtained from the macroscopic transport measurements and the value deduced from the peak height ($l_{m\,fp} = 1.2$ m) discussed above. The di usive scattering is likely due to remote ionized in purity scattering. These results demonstrate that for the given device dimensions, electrons either reach the contacts ballistically or are scattered random ly. This in plies that transport in these structures is in the transition regime between ballistic and di usive transport, which is usually referred to as quasi-ballistic transport.

port.

In conclusion, we have presented the evidence of quasi-ballistic transport in high m obility H gT e QW nanostructures which are fabricated with a technology that overcom es the speci c problem s of H g containing devices. Furtherm ore, a quantitative analysis of the non-local resistance measurements revealed that the actual H gT eQW nanostructure samples allow for a detailed study of the transition from a di usive to a local ballistic transport regim e.

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FIG .1: Scanning electron m icroscope photograph of a cross with 0.45 $\,$ m wide leads.

FIG.2: Non-local resistance signal (NLR) for structures with lead widths of 1.0 m (structure A) and 0.45 m (structure B). The inset shows the NLR of the smaller device for an extended magnetic eld range.

FIG. 3: Experimental data for a 0.45 m device together with the M onte C arlo simulation result (sm ooth curve) for a scattering time of = 1.1 10^{12} s.



